# **HSAutoLink Interconnect System**

The dependable HSAutoLink Interconnect System brings a proven, USCAR-30 compliant solution for point-to-point in-vehicle connections, complete with multiple keying options and full-length cable shielding for superior signal performance and reduced Electro-Magnetic **Interference (EMI)** 

## **Features and Advantages**

Data rates up to 2.0 Gbps in 4 and 5 Circuit Connectors Supports multiple protocols in the same connector (USB 2.0, LVDS, Ethernet, APIX, etc.)

### Multiple polarizations and color-coding available

10 polarizations and colored headers available for either end of the cable assembly. Ensures correct assembly and provides versatility.

# Compact, low-profile system Optimizes device-side space savings to meet future needs

for increasing high-speed communication links

### Full-length cable shielding

Provides superior signal performance and reduced electro magnetic interference (EMI)

### Fully protected shield case

Rear side of right-angle header includes closed shield for robustness, signal integrity, and EMI protection

HSAutoLink Headers and Cable Assemblies



### Headers manufactured from high-temperature plastic material

Compatible with lead-free through-hole reflow process (Pin-in-Paste) or lead-free selective wave soldering process. Meets Jedec 260°C peak temperature

# **Applications**

## Automotive and Commercial Vehicles

- Infotainment
- Telematics
- Navigation Systems
- **Connected Vehicle Services**
- Diagnostics and Data Upload
- Camera to Controller
- Controller to Display



Navigation Systems



Camera to Controller













# HSAutoLink Interconnect System

# molex

# **Specifications**

### REFERENCE INFORMATION

Reference Information Packaging: Headers: Tray Cable assemblies: Loose Mates With: Cable assemblies: 111014, 111015, 111041, 111005 series Designed In: Millimeters RoHS: Yes Halogen Free: No Glow Wire Capable: N/A

### ELECTRICAL

Voltage (max.): 30V Current (max.): 1.5A (higher current rating achievable, contact PM for additional technical Information) Contact Resistance: 20 milliohms

### PHYSICAL

Housing:

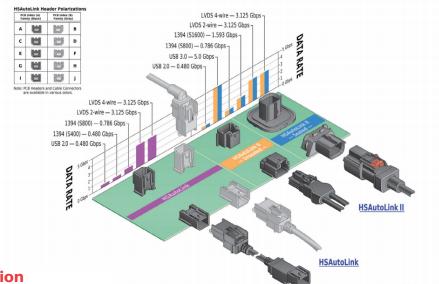
High temperature plastic material Contact: High performance copper alloy Plating: Contact Area - 0.75µm min. Gold (Au)

Solder Tail Area - 3.8µm min. Tin (Sn)

Underplating - 1.25µm min. overall PCB Thickness: 1.6mm nominal Operating Temperature: -40 to +105°C

### MECHANICAL

Insertion Force to PCB: 20N max. Mating Force: 45N max. Unmating Force: 45N max. Durability (min.): Connector: 10 cycles Terminal system: N/A



# **Ordering Information**

### Cable

Series No.	Cable Length	Connector Interfaces Available	Number of Circuits
<u>111005</u>	Customizable Lengths Minimum 220mm	USCAR/USB MINI-B Plug-to-MINI-B Inline Receptacle	5
<u>111014</u>		USCAR/USB MINI-B Plug	5
<u>111015</u>		USCAR/USB TYPE A Receptacle MINI-B Plug	4
<u>111041</u>		LVDS MINI-B Plug MINI-B Inline Receptacle	5

### Header

Header Style (0.80mm pitch)	Series No.	Orientations Available	Application	Termination Interface Style	Number of Circuits
USCAR Mini B HSAutoLink	<u>49616, 104026, 104223</u>	Right-Angle	Signal, Wire-to-Board	Surface Mount, Through Hole	5
USCAR Mini-B HSAutoLink	<u>104004, 104087</u>	Vertical	Signal, Wire-to-Board	Surface Mount, Through Hole	5

## www.molex.com/link/hsautolink.html

Molex is a registered trademark of Molex, LLC in the United States of America and may be registered in other countries; all other trademarks listed herein belong to their respective owners.